Honeywell Security Sensor CoE

2 Corporate Center Dr.Melville New York 11747 United States

Reference: F FCC ID: 2ABC8-PP300850SE

Federal Communications Commission Authorization and Evaluation Division 7435 Oakland Mills Road Columbia, MD 21046

Subject: Class II Permissive change for FCC ID: 2ABC8-PP300850SE, Original Grant date: 02/11/2014

Applicant: Honeywell Security Sensor CoE

TO WHOM IT MAY CONCERN:

This is to reguest a Class II permissive change for FCC ID: 2ABC8-PP300V50SE, originally granted on 02/11/2014 changes files under this application are:

Change:

Some Component and Layout changed.

The FET electrical characteristics are quite closed, yet there are some difference in component shape and dimension.

detail change list as refer as below, Confirmed RF circuit and performance are no changed.:

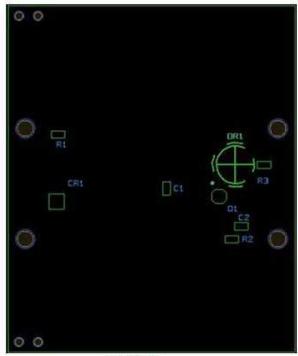
- 1. Replace NE4210S01(300-06289) with CE3512K2(300-09313)
- 2. Replace DR(300-06688) with DR(300-08959)
- 3.Replace Resistor 21ohm(5-108-2212-00) with 33ohm(RJ6-3301)
- 4.PCB minor changed (replace PCB footprint of NE4210S01 with CE3512K2')

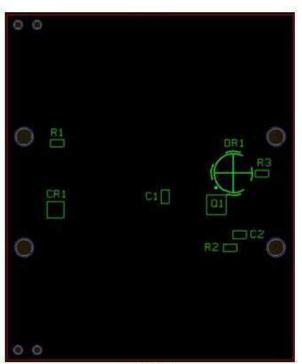
and following table as below:

	Previous				New release				
	Hon eyw ell PN#	Mfr	Mfr PN#	Description	Hon eyw ell PN#	Mfr	Mfr PN#	Description	Note
FET Transistor	300- 0628 9	RENESAS ELECTRONICS CORP	NE42 10S01	X to Ku BAND SUPER LOW NOISE AMPLIFIER	300- 0931 3	CALIFORNIA EASTERN LABORATORIES	CE3512K2- C1	FET,LF,4.0V,10mA, 12 GHz Super Low Noise,SMD, -55 to +125	pin to pin complaint alternative second sourcing
PCB (unpopulat ed)	200- 0102 7	SHENZHEN SHENNAN CIRCUITS CO LTD	200-0 1027	PCB,FR408HR,2LAYERS,1.50I Nx1.81IN,X BAND MW MODEL,8INx5.5IN,12	200- 0186 7	SHENZHEN SHENNAN CIRCUITS CO LTD	200-01867	PCB,FR408HR,2LAYERS,1.50IN x1.81IN,X BAND MW MODEL,8INx5.5IN,12	Small modification as above picture
DR	300- 0668 8	ZHANGJIAGANG FREE TRADE ZONE CAIQIN TECHNOLOGY CO LTD	TE10. 525G HZ-I	RSNTR,10.525GHz,3.6±1.5PP M	300- 0895 9	EXXELIA GROUP	E21936D5. 1F10525+/- 100MHZ	RSNTR,LF,10.525GHz+/-100M HZ,19+/-2ppm/C,-55+125C	Changed
Resistor	5-10 8-22 12-0 0	ROHM CO LTD	MCR0 3EZPF X22R1	RES,LF,Thick Film,22.10hms,1%,0.1W,060 3,SMD,-55C to 155C	RJ6- 3301	ROHM CO LTD	MCR03EZP FX33R0	RES,LF,33R, 1%, 0.1W, SMD, 0603, -55C to +125C	Changed
PC microwave shield (Plastic)	700- 0331 3	RILONG TECHNOLOGY (SHENZHEN) CO LTD	700-0 3313	SHIELD,X-BAND PLANAR,CARBON FILLED PLASTIC	700- 0523 5	RILONG TECHNOLOGY (SHENZHEN) CO LTD	100-07157	SHIELD,X-BAND PLANAR,CARBON FILLED PLASTIC	Small modification

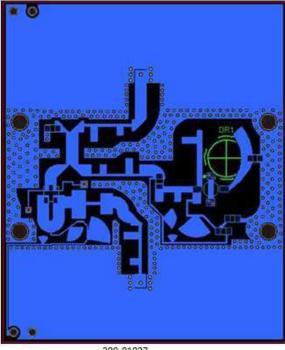
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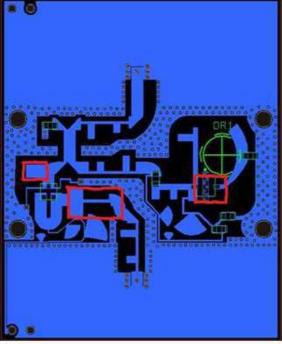
• PCB layout change in back layer block in RED Difference of PCB layout





200-01027 200-01867.





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Sincerely,

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